

#### **N-Channel Enhancement Mode Field Effect Transistor**

# **General Description**

The CMSA150N03 uses advanced trench technology to provide excellent RDS (ON), low gate charge and minimize the loss of power conversion applications.

## **Features**

- RDS(ON)<2.7mΩ @ VGS=10V
- 100% avalanche tested
- RoHS and Halogen-Free Compliant
- High Current Capability

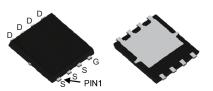
# **Product Summary**

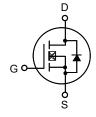
BVDSS	RDSON	ID
30V	2.7mΩ	150A

### **Applications**

- DC/DC Converters in Computing, Servers, and POL
- Isolated DC/DC Converters in Telecom and Industrial

# **DFN-8 5x6 Pin Configuration**





DFN-8 5x6

Туре	Package	Marking
CMSA150N03	DFN-8 5*6	CMSA150N03

### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	30	V	
$V_{GS}$	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current	150	Α	
I <sub>D</sub> @T <sub>C</sub> =100℃	Continuous Drain Current	110	А	
I <sub>DM</sub>	Pulsed Drain Current	450	А	
EAS	Single Pulse Avalanche Energy	140	mJ	
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation	110	W	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	$^{\circ}$	
TJ	Operating Junction Temperature Range -55 to 150		$^{\circ}$ C	

### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient		55	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction -Case		1.5	°C/W



#### **N-Channel Enhancement Mode Field Effect Transistor**

# Electrical Characteristics (T<sub>J</sub>=25℃ , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
Б	Static Drain-Source On-Resistance	$V_{GS}$ =10V , $I_D$ =20A		2	2.7	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		2.5	3.5	
VGS(th)	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250\mu A$	1		2.5	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =30V , V <sub>GS</sub> =0V			1	uA
200	Brain Godroe Ecanage Carroni	V <sub>DS</sub> =30V , V <sub>GS</sub> =0V ,Tc=55 °C			5	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ =±20V , $V_{DS}$ =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =15A		15		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		9		Ω
$Q_g$	Total Gate Charge	V <sub>DS</sub> =15V , I <sub>D</sub> =20A 		50		
Q <sub>gs</sub>	Gate-Source Charge			8		nC
$Q_gd$	Gate-Drain Charge			10.5		
$T_{d(on)}$	Turn-On Delay Time			7.5		
T <sub>r</sub>	Rise Time	$V_{DS}$ =15V , $V_{GS}$ =10V , $R_{GEN}$ =3 $\Omega$ RL=0.75 $\Omega$		5		ns
$T_{d(off)}$	Turn-Off Delay Time			34		115
$T_f$	Fall Time			10		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		7000		
C <sub>oss</sub>	Output Capacitance			800		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			450		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Diode continuous forward current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			150	Α
I <sub>S,pulse</sub>	Diode pulse current				450	Α
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>F</sub> =15A , Tj=25°C			1	V

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